



60V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C (Note 7)
60V	3.1mΩ @ V _G S = 10V	100A

Description and Applications

This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP and is ideal for use in:

- DC motor controls
- Synchronous rectifications
- DC-DC converters

Site 1:



Site 2:

PowerDI5060-8/SWP (Type UX)



Top View



Bottom View

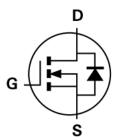
Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- Low R_{DS(ON)} Minimizes Power Losses
- Low Q_g Minimizes Switching Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH6004SPSQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

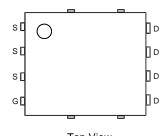
https://www.diodes.com/quality/product-definitions/

Mechanical Data

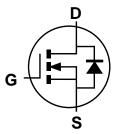
- Package: PowerDI[®]5060-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 [®]
- Weight: 0.097 grams (Approximate)



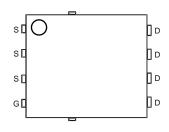
Internal Schematic



Top View Pin Configuration



Internal Schematic



Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Package	Packing		
Fait Nullibei	rackage	Qty.	Carrier	
DMTH6004SPSQ-13	PowerDI5060-8	2,500	Tape & Reel	
DMTH6004SPSQ-13	PowerDI5060-8/SWP (Type UX)	2,500	Tape & Reel	

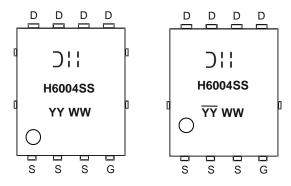
Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Document number: DS37561 Rev. 5 - 2



Marking Information



⊃¦¦ = Manufacturer's Marking H6004SS = Product Type Marking Code
YYWW = Date Code Marking
YY or YY = Year (ex: 23 = 2023) WW = Week (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			V _{DSS}	60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5)		lo	25 21	А	
Continuous Drain Current (Notes 6 & 7) $ T_C = +25^{\circ}C $ $T_C = +100^{\circ}C $			ΙD	100 100	А
Maximum Continuous Body Diode Forward Current (Notes 6 & 7)			Is	100	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	400	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			Ism	400	Α
Avalanche Current, L=0.2mH			las	45	Α
Avalanche Energy, L=0.2mH			Eas	200	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	$T_A = +25$ °C	PD	3.2	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	47	°C/W
Total Power Dissipation (Note 6)	Tc = +25°C	PD	167	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	0.9	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +175	°C

5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate.6. Thermal resistance from junction to soldering point (on the exposed drain pad).7. Package limited. Notes:



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

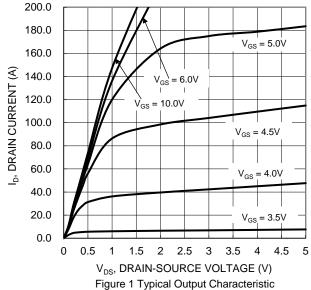
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 8)							
Drain-Source Breakdown Voltage		BV _{DSS}	60	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$
7 0		I _{DSS}	_	_	1	μΑ	$V_{DS} = 48V$, $V_{GS} = 0V$
Zero Gate Voltage Drain Current	(Note 9)		_	_	100	μΑ	V _{DS} = 48V, V _{GS} = 0V, T _J = +125°C
Gate-Source Leakage		Igss	_	_	±100	nA	Vgs = ±20V, Vps = 0V
ON CHARACTERISTICS (Note 8)							
Gate Threshold Voltage		V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
Static Drain-Source On-Resistance		R _{DS(ON)}	_	2.5	3.1	mΩ	$V_{GS} = 10V, I_D = 50A$
Diode Forward Voltage		VsD	_	0.9	1.2	V	$V_{GS} = 0V$, $I_{S} = 20A$
DYNAMIC CHARACTERISTICS (Note 9)							
Input Capacitance		Ciss	_	4556	_		V 00V V 0V
Output Capacitance Reverse Transfer Capacitance		Coss	_	1383	_	pF	$V_{DS} = 30V$, $V_{GS} = 0V$, $f = 1MHz$
		Crss	_	105.2	_		
Gate Resistance		Rg	0.1	0.66	1.9	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$
Total Gate Charge		Qg	_	95.4	_		V 20V I 00A
Gate-Source Charge		Qgs	_	21.6	_	nC	$V_{DD} = 30V, I_{D} = 90A,$ $V_{GS} = 10V$
Gate-Drain Charge		Q_{gd}	_	20.4	_		
Turn-On Delay Time		td(ON)	_	13.2	_		
Turn-On Rise Time		t _R	_	11.7	_		$V_{DD} = 30V, V_{GS} = 10V,$
Turn-Off Delay Time		t _{D(OFF)}	_	31	_	ns	$I_D = 90A, R_G = 3.5\Omega$
Turn-Off Fall Time		tF	_	12	_		
Body Diode Reverse Recovery Time		trr	_	50.5	_	ns	L 504 di/dt 1004/up
Body Diode Reverse Recovery Charge		Qrr	_	80.8	_	nC	I _F = 50A, di/dt = 100A/μs

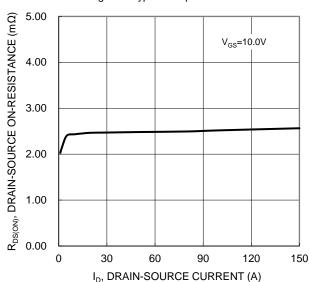
Notes:

^{8.} Short duration pulse test used to minimize self-heating effect. 9. Guaranteed by design. Not subject to product testing.









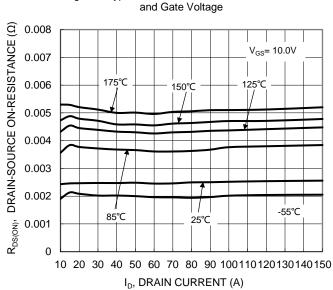


Figure 3 Typical On-Resistance vs. Drain Current

Figure 5 Typical On-Resistance vs. Drain Current and Temperature

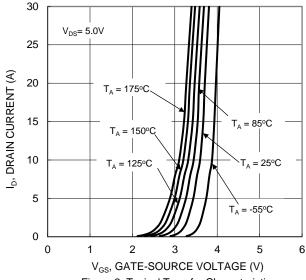
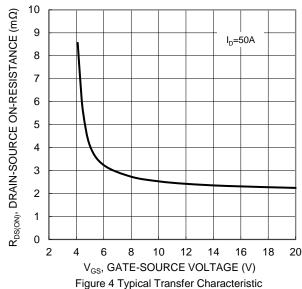


Figure 2 Typical Transfer Characteristic

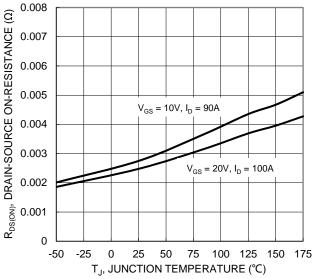


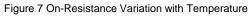
2.2 RDS(ON), DRAIN-SOURCE ON-RESISTANCE 2 1.8 $V_{GS} = 10V, I_{D}$ 1.6 (NORMALIZED) 1.4 1.2 $V_{GS} = 20V, I_D = 100A$ 1 8.0 0.6 0.4 -25 -50 25 50 75 100 125 150 175 T_J, JUNCTION TEMPERATURE (°C)

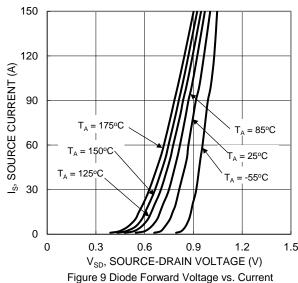
Figure 6 On-Resistance Variation with Temperature











8 6 V_{DS}=30V, I_D=90A 2

Qg (nC) Figure 11 Gate Charge

50 60

70 80

90 100

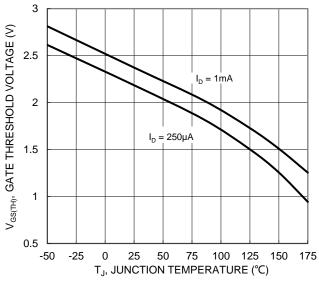
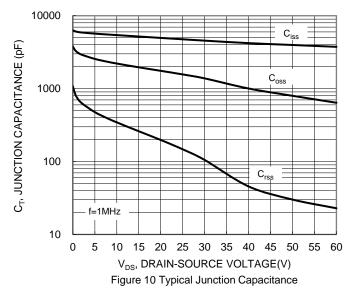


Figure 8 Gate Threshold Variation vs. Temperature



1000 $\boldsymbol{R}_{DS(ON)}$ Limited 100 ID, DRAIN CURRENT (A) 10 $P_W = 10ms$ $P_W = 100 \mu s$ $T_{J(Max)} = 175$ °C T_C = 25°C $P_W = 10 \mu s$ Single Pulse **DUT** on Infinite Heatsink V_{GS}= 10V 0.1 0.1 100 $\rm V_{\rm DS}$, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

0

0 10 20 30 40

10



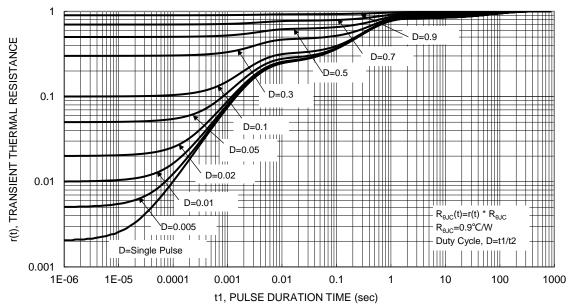


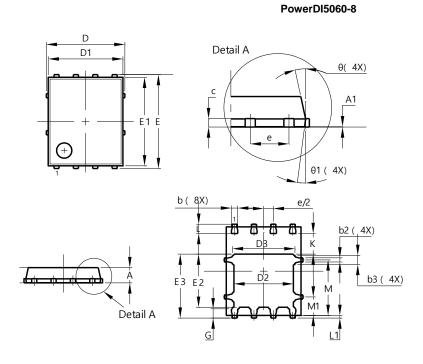
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

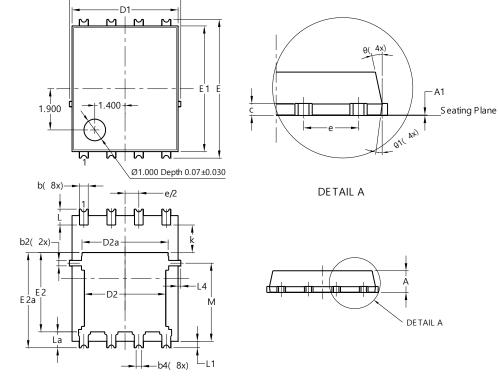
Site 1:



PowerDI5060-8					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0.00	0.05	_		
b	0.33	0.51	0.41		
b2	0.200	0.350	0.273		
b3	0.40	0.80	0.60		
С	0.230	0.330	0.277		
D		5.15 BSC	;		
D1	4.70	5.10	4.90		
D2	3.70	4.10	3.90		
D3	3.90	4.30	4.10		
E	(6.15 BSC	;		
E1	5.60	5.60 6.00			
E2	3.28	3.68	3.48		
E3	3.99	4.39	4.19		
е	1.27 BSC				
G	0.51	0.71	0.61		
K	0.51	_	_		
L	0.51	0.71	0.61		
L1	0.100	0.200	0.175		
M	3.235	4.035	3.635		
M1	1.00	1.40	1.21		
Θ	10°	12°	11°		
Θ1	6°	8°	7°		
All Dimensions in mm					

Site 2:

PowerDI5060-8/SWP (Type UX)



PowerDI5060-8/SWP (Type UX)					
Dim	Min	Max	Тур		
Α	0.90	1.10	1.00		
A1	0	0.05			
b	0.30	0.50	0.41		
b2	0.20	0.35	0.25		
b4	().25REF	•		
С	0.230	0.330	0.277		
D	5	.15 BS0	\sim		
D1	4.70	5.10	4.90		
D2	3.56	3.96	3.76		
D2a	3.78	4.18	3.98		
Е	6	.40 BS0			
E1	5.60				
E2	3.46	3.86	3.66		
E2a	4.195	4.595	4.395		
е	1.27BSC				
k	1.05				
L	0.635	0.835	0.735		
La	0.635	0.835	0.735		
L1	0.200	0.400	0.300		
L1a	0.050REF				
L4	0.025	0.225	0.125		
М	3.205	4.005	3.605		
θ	10°	12°	11°		
θ1	6°	8°	7°		
All Dimensions in mm					

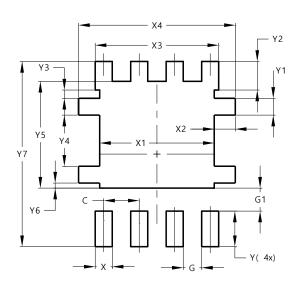


Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

Site 1:

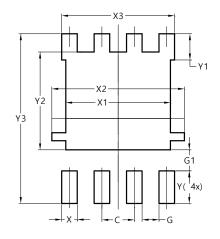
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site 2:

PowerDI5060-8/SWP (Type UX)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	5.190
Х3	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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